

Minitek® Headers

2.00mm pitch

BOARDS PRODUCTS SOLUTIONS

Minitek® is Amphenol FCI's brand for board-to-board and wire/cable-to-board connectors in 2.00mm pitch. The Minitek® product range includes PCB Card Connectors, Shrouded and Unshrouded headers and IDC/CTW receptacles.

Amphenol FCI is adding five new series of Minitek® Headers to its product range, dedicated to Pin-in-Paste soldering processes.

- Easy to operate and strong FFC/FPC retention makes it vibration-proof
- Ensures high solderability and high durability
- Operating temperature range of -55°C to +85°C



TARGET MARKETS



FEATURES

- Modular System
- 2mm pitch available
- Lowest co-planarity at 0.1mm
- 0.5mm square drawn wire pin
- High raw material temperature range

BENEFITS

- Ensures interchangeable solution for flexible design
- 38% less board space compared with 2.54mm
- Facilitates automatic placement with no orientation constraint on PCB
- Provides four smooth mating surfaces
- Withstands re-flow soldering process

TECHNICAL INFORMATION

UNSHROUDED/STACKING

MATERIAL

- Housing: High temperature thermoplastic
- Color: Black
- Flammability Rating: UL94V-0
- Pin: Phosphor bronze
- Plating: Gold and tin over 1.27µm nickel

MECHANICAL PERFORMANCE

- Pin Retention: 7N min.

ELECTRICAL PERFORMANCE

- Current Rating: 1A continuous
- Insulation Resistance: 1000WM min.
- Dielectric Withstanding Voltage: 650V

ENVIRONMENTAL

- Operating Temperature Range: -55°C to +125°C

APPROVALS & CERTIFICATION

- RoHS compatible according to the European Union Directive 2002/95/IEC

SPECIFICATIONS

- File Number: E66906
- File Number: LR46923
- Product Drawing: By 8-digit base part number
- Product Specification: DPS-12-011 and GS-12-163
- Application Specification: TA-895
- Re-flow Profile: TA-842

PROCESSING INFORMATION

- Compatible with IR re-flow soldering processes

TARGET MARKETS/APPLICATIONS



Automotive



Communications



Data



Industrial & Instrumentation



Medical

TECHNICAL INFORMATION

SHROUDED

MATERIAL

- Housing: High temperature thermoplastic
- Colour: Black
- Flammability Rating: UL94V-0
- Pin: Phosphor bronze
- Plating: Gold and tin over 1.27µm nickel

MECHANICAL PERFORMANCE

- Pin Retention: 7N min.

ELECTRICAL PERFORMANCE

- Current Rating: 2A continuous
- Insulation Resistance: 1000WM min.
- Dielectric Withstanding Voltage: 650V

ENVIRONMENTAL

- Operating Temperature Range: -40°C to +125°C

APPROVALS & CERTIFICATION

- RoHS compatible according to the European Union Directive 2002/95/IEC

SPECIFICATIONS

- File Number: E66906
- File Number: LR46923
- Product Drawing: By 8-digit base part number
- Product Specification: DPS-12-011 and GS-12-163
- Application Specification: TA-896
- Reflow Profile: TA-842

PROCESSING INFORMATION

- Compatible with IR reflow soldering processes

TARGET MARKETS/APPLICATIONS



Electronic Control Systems



Communications



Servers
Communication Equipment



Industrial Automation
Instrumentation



Vending Machines

PART NUMBERS

Description	Part Numbers
Unshrouded Header, Vertical, Single Row, TMT / PiP	10138654
Unshrouded Header, Vertical, Double Row, TMT / PiP	57102
Unshrouded Header, Vertical, Double Row, SMT	57202
Unshrouded Stacking Header, Vertical, Double Row, TMT	59112
Unshrouded Stacking Header, Vertical, Double Row, SMT	59202
Unshrouded Header, Right-Angle, Single Row, SMT	10112684
Unshrouded Header, Right-Angle, Double Row, TMT	98423
Unshrouded Header, Right-Angle, Double Row, SMT	10112690
Unshrouded Header, Right-Angle, Double Row, PiP	10072353
Shrouded Header, Right-Angle, Single Row, SMT	95000
Shrouded Header, Right-Angle, Double Row, TMT	98464
Shrouded Header, Vertical, Double Row, TMT	98414
Shrouded Header, Vertical, Double Row, SMT	98424

▶ Minitek® Headers

PIN-IN-PASTE

Pin-in-Paste (PiP) technology allows the use of TMT products in SMT manufacturing processes. The connectors are automatically or manually placed on the board, then soldered in the same operation as the SMT components. Despite this, the mechanical strength of the TMT soldering is maintained – still an important requirement for connectors nowadays in many industrial or automotive applications.

CONNECTOR DESIGN

In order to achieve optimum soldering results, Amphenol FCI launches dedicated Pin-in-Paste connectors in the basics+ product range. These connectors are fully adapted to Pin-in-Paste processing in all aspects, including plastic material, housing design, pin length, and packaging.

PLASTIC MATERIAL

Minitek PiP headers are molded in high temperature thermoplastic and are able to withstand exposure to 260°C peak temperature for 30 seconds maximum in a convection, infra-red or vapour phase reflow oven.

PIN LENGTH

The connector lead length beyond the bottom of the PCB is shorter than for traditional TMT products. Thus, the risk of pushing out the solder paste when inserting the pin into the PCB hole is very much limited. The solder paste will not stick on the pin tip or even fall off completely, but stays around the pin for free flow during soldering. Amphenol FCI uses a solder tail length of $2 \pm 0.2\text{mm}$ for Minitek Headers for a standard PCB of 1.6mm thickness.

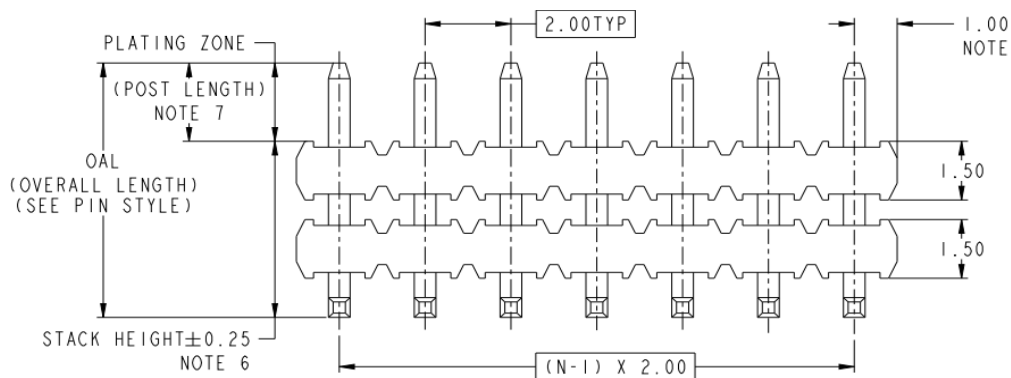
HOUSING DESIGN

Standoffs raise the housing body slightly above the PCB surface and thus allow the molten solder paste to flow freely from its printed position into the board hole and around the pin. The standoffs are correctly positioned for a good solder paste deposit around the pin. Please respect the stencil design guidelines below in order to avoid paste deposit around the standoffs.

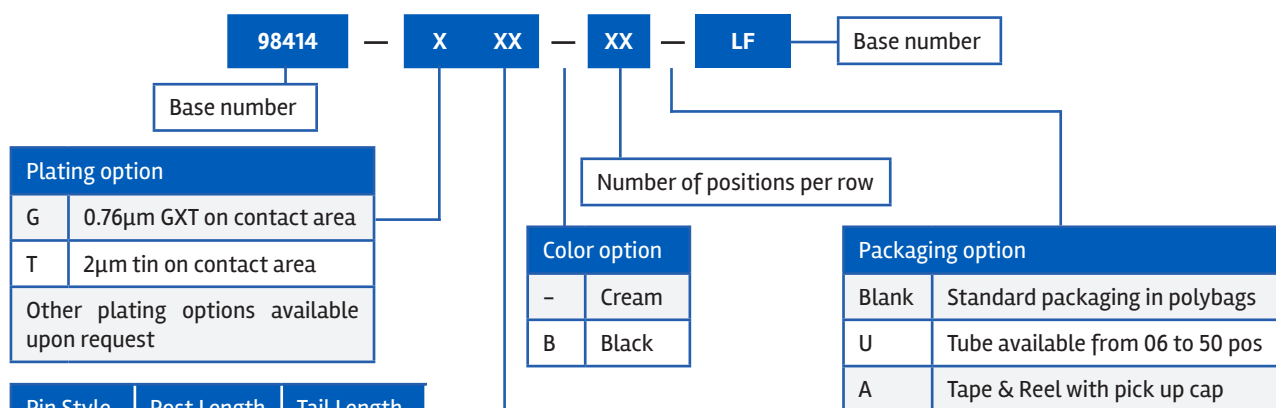
PACKAGING

For combining SMT and TMT components not only in the soldering process, but also in the assembly process, Amphenol FCI proposes a choice of pick-and-place packaging for PiP connectors. The most common part numbers are available in tape-on-reel packaging, all others in tube.

SHROUDED



PART NUMBER SELECTOR HEADER



Description	Part Numbers
Unshrouded Header, Vertical, Single Row, TMT / PiP	10138654
Unshrouded Header, Vertical, Double Row, TMT / PiP	57102
Unshrouded Header, Vertical, Double Row, SMT	57202
Unshrouded Stacking Header, Vertical, Double Row, TMT	59112
Unshrouded Stacking Header, Vertical, Double Row, SMT	59202
Unshrouded Header, Right-Angle, Single Row, SMT	10112684
Unshrouded Header, Right-Angle, Double Row, TMT	98423
Unshrouded Header, Right-Angle, Double Row, SMT	10112690
Unshrouded Header, Right-Angle, Double Row, PiP	10072353
Shrouded Header, Right-Angle, Single Row, SMT	95000
Shrouded Header, Right-Angle, Double Row, TMT	98464
Shrouded Header, Vertical, Double Row, TMT	98414
Shrouded Header, Vertical, Double Row, SMT	98424

Minitek® 2.00mm Receptacle

Single and double row

MODULAR AND COMPACT SOLUTION

The Minitek® product family includes single and double row receptacles for Board-to-Board and Wire-to-Board applications, in 2 to 25 positions per row and in vertical and horizontal configurations.

- Selective plating option saves costs
- Double solder tail on each pitch for SR VCC ensures no orientation constraint
- 2Amps performance with more than one contact powered
- Horizontal configuration is ideal for coplanar applications
- Modular system ensures interchangeable solution for flexible design



TARGET MARKETS



FEATURES

- Double solder tail on each pitch for Single Row (SR) Vertical Card Connector (VCC)*
- 2Amps with more than one contact powered
- Selective plating
- Low profile version available (2.3mm height)
- Modular system is fully intermateable
- Smaller pitch of 2.00mm
- Dual beam contact design
- Perpendicular or coplanar application
- High raw material temperature range

BENEFITS

- Facilitates automatic placement with no orientation constraint
- Meet higher power Amps performance requirements
- Cost efficient
- Meets specific design requirements
- Interchangeable solution offers design flexibility
- 38% less board space compared with 2.54mm connectors
- Highly reliable electrical performances
- Vertical or horizontal mounting solution
- Withstands re-flow soldering process

TECHNICAL INFORMATION

MATERIAL

- Housing: High Temperature Thermoplastic, Black, UL94V-0
- Pin: Phosphor Bronze
- Plating:
 - 1= 0.76µm Gold/GXT® on contact area and 2µm min. matte tin on tail
 - 2= 0.38µm Gold/GXT® on contact area and 2µm min. matte tin on tail
 - 3= 0.20µm Gold/GXT® on contact area and 2µm min. matte tin on tail
 - 9= 1.27µm Nickel min. under layer and 2µm matte in on tail

MECHANICAL PERFORMANCE

- Durability: 100 mating cycles

ELECTRICAL PERFORMANCE

- Dielectric Withstanding Voltage: 650V
- Insulation Resistance: 1000MΩ min.
- Current Rating: 2A (all contacts powered)

PACKAGING

- Tube
- Tape

APPROVALS & CERTIFICATION

- UL94 V-0 & CSA

SPECIFICATION

- Amphenol Product Specification: GS-12-1326

ENVIRONMENTAL

- Operating Temperature: -55°C to +125°C

TARGET MARKETS/APPLICATIONS



Electronic Control Systems



Communications



Servers
Communication Equipment



Industrial Automation
Instrumentation



Vending Machines

Description	Part Numbers
PCB Receptacle, Vertical, Single Row, TMT	10131934
PCB Receptacle, Vertical, Single Row, SMT	10131935
PCB Receptacle, Vertical, Double Row, TMT	10131936
PCB Receptacle, Vertical, Double Row, SMT	10131937
PCB Receptacle, Horizontal, Single Row, TMT	10131931
PCB Receptacle, Horizontal, Single Row, SMT	10131930
PCB Receptacle, Horizontal, Double Row, TMT	10131932
PCB Receptacle, Horizontal, Double Row, SMT	10131933

PART NUMBER SELECTOR PCB RECEPTACLE

